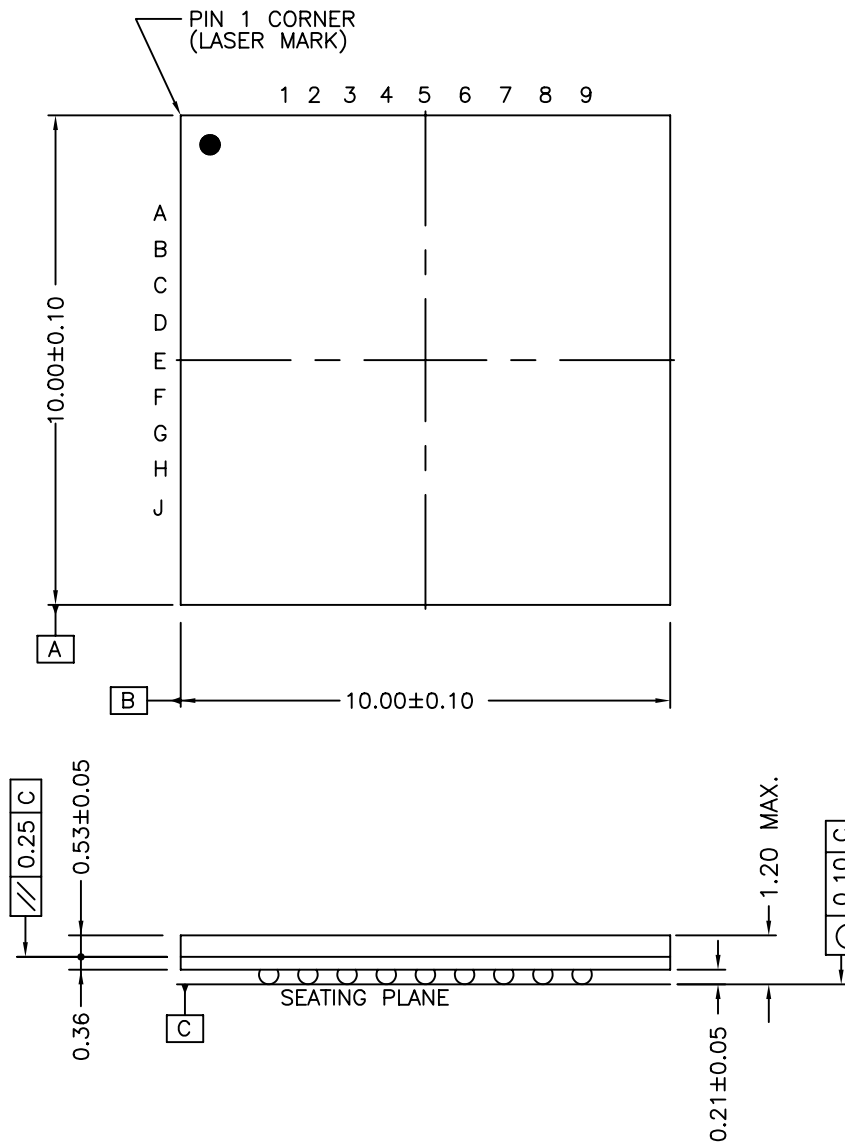
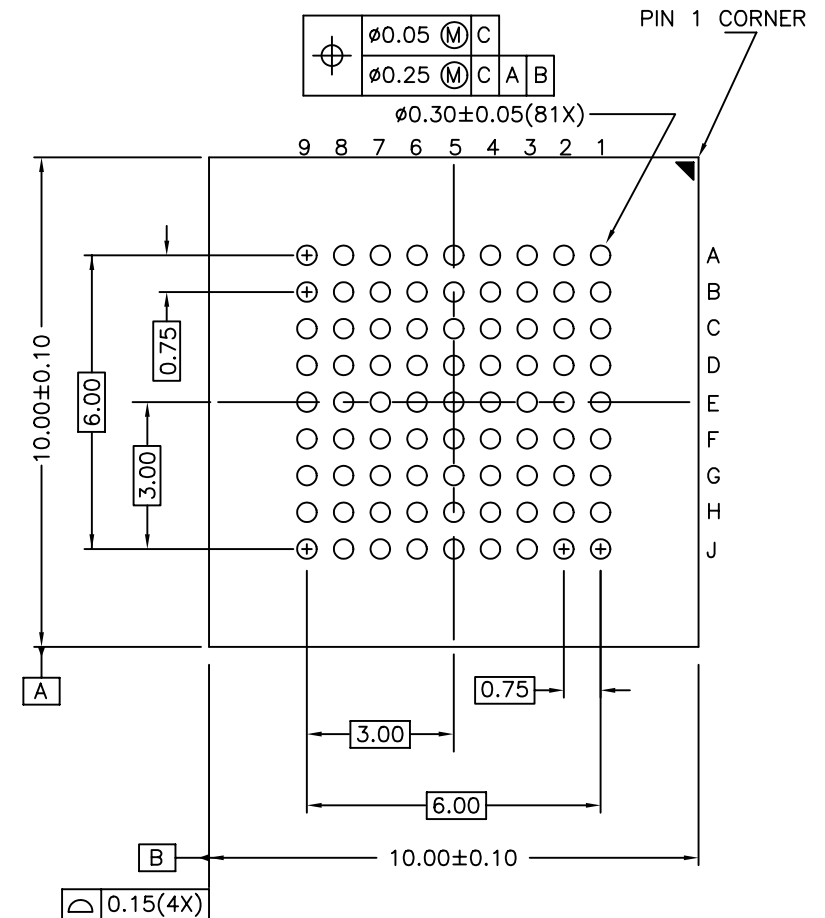


REVISIONS				
ZONE	REV	ECN	DESCRIPTION	DATE
	**	106864	NEW RELEASE	04/30/01
	*A	107718	DELETE LETTER "I" REPLACE BY "J" (LAST ROW)	06/05/01
	*B	117245	CHG. PKG. BODY TOLERANCE/ ADD SUBSTRATE & MOLD CAP DIM./ CHG. TITLE.	07/12/02

TOP VIEW



BOTTOM VIEW



UNLESS OTHERWISE SPECIFIED				DESIGNED BY			
ALL DIMENSIONS ARE IN MILLIMETERS				DATE			
STANDARD TOLERANCES IN:				DRAWN			
DECIMALS	ANGLES			HTN	DATE	07/12/02	
JXX ±	°			CHK BY	DATE		
JXXX ±				APPROVED BY	DATE		
JXXX ±				APPROVED BY	DATE		
MATERIAL				TITLE			
FINISH				81 FBGA (10.0 X 10.0 X 1.2MM) PKG. OUTL.			
				CYPRESS SEMICONDUCTOR			
				SIZE			
				A			
				PART NO.			
				BA81			
				DWG NO			
				51-85140			
				REV			
				*B			
				SCALE			
				1:1			
				SHEET 1 OF 1			